

# SPECIFICATIONS

---

Dot matrix Display 点阵产品规格书

**TOPLITE**



**MODEL: TOP-CC-3057AS**

---

**上海鼎晖科技股份有限公司**

SHANGHAI TOPLITE TECHNOLOGY CO.,LTD.

[www.ledtoplight.com.cn](http://www.ledtoplight.com.cn)

[www.ledtoplite.com](http://www.ledtoplite.com)



## TECHNICAL DATA SHEET

**TOP-CC-3057AS** FOR  $\Phi 7.6\text{MM } 5 \times 7$  DOT MATRIX DIGITI

1 / 6

### 1. PRODUCT INTRODUCTION

- ※ Low power requirement,
- ※ Solid state reliability.
- ※ Wide viewing angle.
- ※ Easy mounting on P.C. boards.
- ※ RHOS compliant.

### 2. FEATURES

- ※ TOP-CC-3057AS is a 1.1 inch (27.6mm)5\*7 DOT MATRIX.
- ※ This device is made with white dots and black surface.

### 3. APPLICATION

- ※ Digital readout display.
- ※ Instrument panels.
- ※ Elevator.

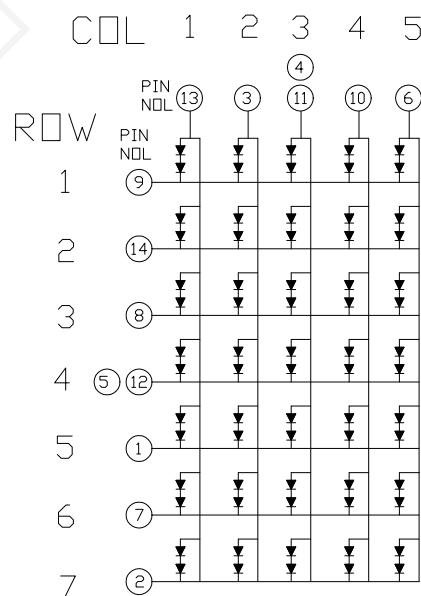
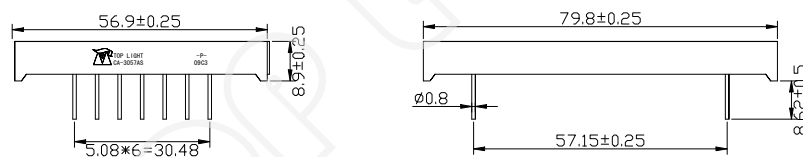
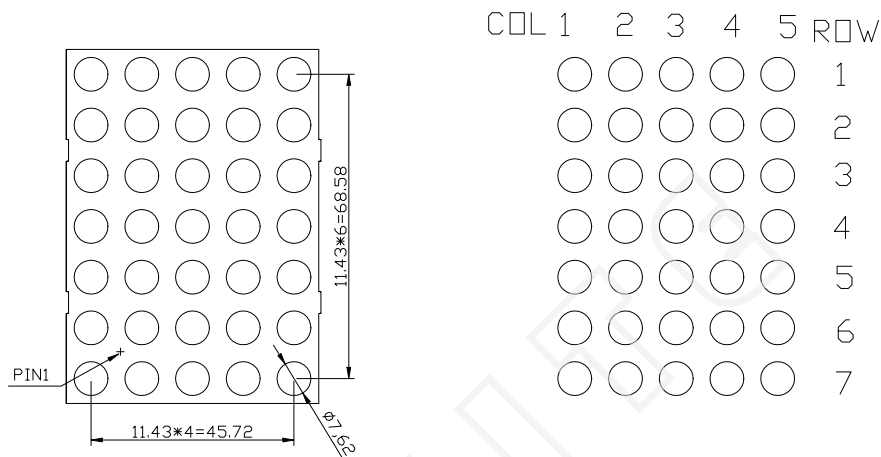
PART NO.	SIZE	CHIP EMITTED COLOR	FACE COLOR
TOP-CC-3057AS	$\Phi 7.6\text{MM } 5 \times 7$	Red	Black

## TECHNICAL DATA SHEET

TOP-CC-3057AS FOR  $\Phi 7.6\text{MM } 5 \times 7$  DOT MATRIX DIGITI

2 / 6

### 4. PACKAGE DIMENSIONS & CIRCUIT DIAGRAM





## TECHNICAL DATA SHEET

TOP-CC-3057AS FOR  $\Phi 7.6\text{MM } 5 \times 7$  DOT MATRIX DIGITI

3 / 6

## 5. ELECTRICAL/OPTICAL CHARACTERISTIC

5-1. ABSOLUTE MAXIMUM RATINGS ( $T_a=25^\circ\text{C}$ )

PARAMETER	SYMBOL	VALUE	UNIT
Reverse Voltage	$V_R$	5	V/dot
Forward Current	$I_F$	30	mA/dot
Peak Forward Current (1/10 Duty Cycle)	$I_{PEAK}$	120	mA/dot
Power Dissipation	$P_D$	80	mW/dot
Operating Temperature Range	$T_A$	- 25 ~ + 85	$^\circ\text{C}$
Storage Temperature Range	$T_{STG}$	- 30 ~ + 85	$^\circ\text{C}$
Solder Temperature	$T_{sol}$	260/3	$^\circ\text{C/s}$

5-2. ELECTRICAL-OPTICAL CHARACTERISTICS ( $T_a=25^\circ\text{C}$ )

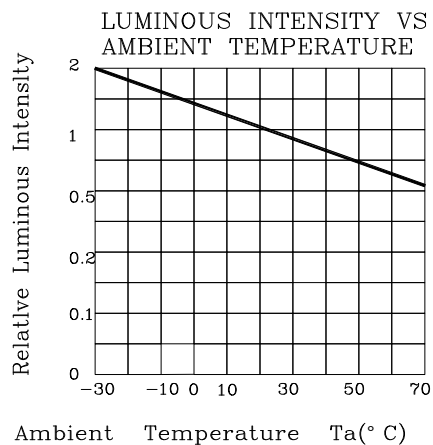
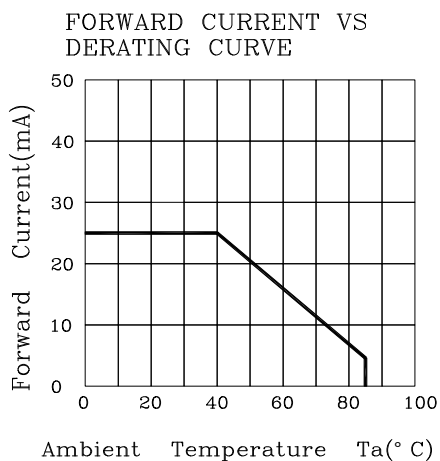
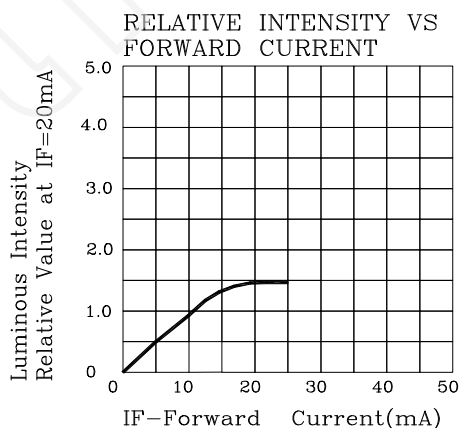
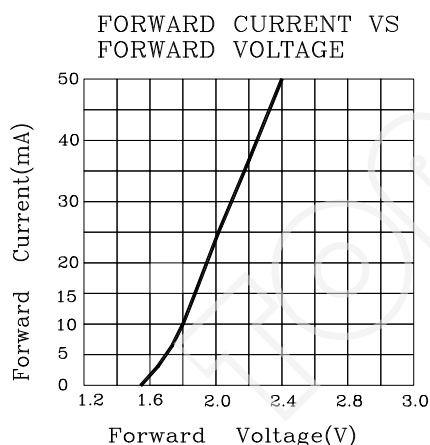
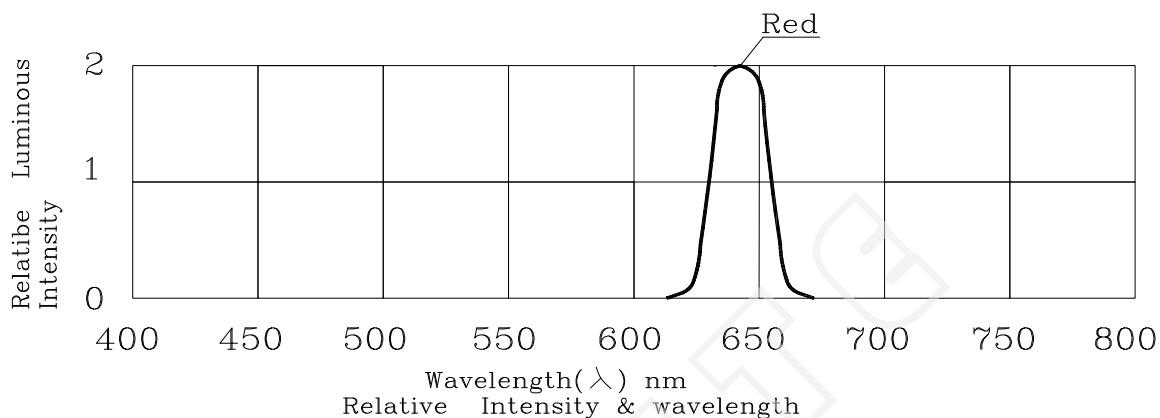
PARAMETER	SYMBOL		MIN.	TYP.	MAX.	UNIT	TEST CONDITIONS
Luminous Intensity	$I_V$	P	10384	11941.5	13499	ucd	$I_F=10\text{mA}$
		R	13500	15524.5	17549		
		S	17550	21937.5	26325		
Forward Voltage	$V_F$		1.80	2.10	2.40	v/dot	$I_F=20\text{mA}$
Chromatographer	$\lambda_p$		-	640	-	nm	$I_F=20\text{mA}$
Spectral Line Half-Width	$\Delta \lambda$		-	20	-	nm	$I_F=20\text{mA}$
Reverse Current	$I_R$		-	-	20	$\mu\text{A}$	$V_R=5\text{V}$

## TECHNICAL DATA SHEET

TOP-CC-3057AS FOR  $\Phi 7.6\text{MM } 5 \times 7$  DOT MATRIX DIGITI

4 / 6

### 5-3. OPTICAL CHARACTERISTIC CURVES





## TECHNICAL DATA SHEET

TOP-CC-3057AS FOR  $\Phi 7.6\text{MM } 5 \times 7$  DOT MATRIX DIGITI

5 / 6

## 6. QUALITY CONTROL AND ASSURANCE

CLASSIFICATION	TEST ITEM	TEST CONDITION
ENDUTRANCE TEST	OPERATION LIFE	Ta=under room temperature If=12mA-25mA per segment or Ip=80mA/duty=1/8,Pw=1.25mS Ip=160mA/duty=1/16,Pw=1.mS(DOT) Test time=1000HRS(-24HRS+72HRS)
	MOISTURE	Ta=65°C±5°C RH=90-95% Test time=240HRS±2HRS
	HIGH TEMPERATURE HIGH HUMIDITY REVERSE BIAS	Ta=65°C±5°C RH=90-95% VR=5V Test time=500hrs(-24HRS+48HRS)
	HIGH TEMPERATURE STORAGE	To evaluate device's durability for long term storage in high temperature Ta=85°C±5°C Test time=1000HRS(-24HRS+72HRS)
	LOW TEMPERATURE STORAGE	Ta=-35°C±5°C Test time=1000HRS(-24HRS+72HRS)
ENVIRONMENTAL TEST	TEMPERATURE CYCLING	Ta=85°C~25°C~-35°C time=30min 5min 30min 5min Cycle test:10cycles
	THERMAL SHOCK	Ta=85°C±5°C~-35°C±5°C time=10min 10min Cycle test:10cycles
	SOLOER RESISTANCE	T.sol=260°C±5°C time=10±1sec
	SOLOER ABILITY	T.sol=230°C±5°C time=5±1sec

## TECHNICAL DATA SHEET

TOP-CC-3057AS FOR  $\Phi 7.6\text{MM } 5 \times 7$  DOT MATRIX DIGITI

6 / 6

### 7. SOLDERING CONDITIONS

The recommended conditions for soldering are as follows.

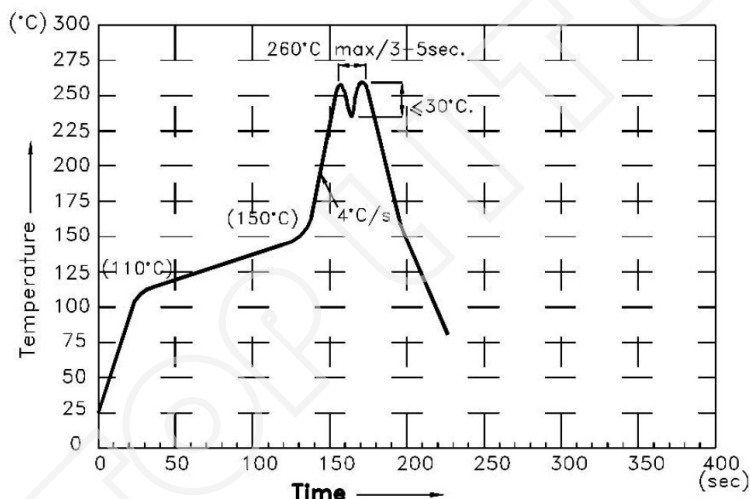
Because the component is made with epoxy resin, the units are susceptible to heat. Therefore, the preheating and soldering temperatures should be kept as low as possible to avoid damage.

#### 7-1. Manual Soldering Conditions(with 1.5mm Iron tip ).

Iron Tip Temperature: 350°C Max, Time: 3s Max.

Position: The iron should be situated at least 2mm away from the root of the leads.

#### 7-2. Through the Wave Soldering Conditions Wave Soldering Profile For Lead-free Through-hole LED.



#### 7-3. Soldering General Notes:

- Recommend manual soldering to be used only for repair and rework purposes. The soldering iron should not exceed 30W in power. The tip of the soldering iron should not touch the reflector case to avoid heat-damage.
- Maintain the pre-heat and peak temperatures with dip units as low as possible and the times as short as is feasible, since the products are susceptible to heat during flow soldering.
- After soldering, least three minutes for the component to cool to room temperature before further operations.
- If components will undergo multiple soldering processes, or other processes where the components may be subjected to intense heat, please check with toplight for compatibility.